

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|---|--|------------------|---------|------------------|
| L5 | 152 | ("204"/\$.ccls. or "205"/\$.ccls.) and (fac\$3 adj up) with (fac\$3 adj down) | US-PGPUB; USPAT | OR | ON | 2005/09/01 08:44 |
| L6 | 104 | I5 and (polishing or planariz\$5) | US-PGPUB; USPAT | OR | ON | 2005/09/01 09:01 |
| L7 | 1 | "6416647".pn. | US-PGPUB; USPAT | OR | ON | 2005/09/01 09:39 |
| L8 | 282 | scott near2 moore | US-PGPUB; USPAT | OR | ON | 2005/09/01 09:40 |
| L9 | 166 | (scott near2 moore) and polishing | US-PGPUB; USPAT | OR | ON | 2005/09/01 09:40 |
| L10 | 27 | (scott near2 moore) and polishing and electrode | US-PGPUB; USPAT | OR | ON | 2005/09/01 09:41 |
| S1 | 3 | "2002025760".pn. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 12:45 |
| S6 | 1 | 10/090869 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/30 11:22 |
| S9 | 14 | ("6722942" "6736952").PN. or ("20020115283" "20040192052" "20050059324" "5162248" "6176992" "6395607" "6433929" "6504247" "6753250" "6780772" "6881664").PN. or ("20030064669").PN. | US-PGPUB; USPAT | OR | ON | 2005/08/30 15:22 |
| S10 | 1 | 10/157466 | US-PGPUB; USPAT | OR | ON | 2005/08/30 14:04 |
| S11 | 15 | 09/651779 | US-PGPUB; USPAT | OR | ON | 2005/08/30 15:23 |
| S12 | 1116 | ("204"/\$.ccls. or "205"/\$.ccls.) and (AC or (alternat\$4 adj current)) and (DC or (direct adj current)) same switch\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 12:47 |
| S13 | 228 | S12 and (plating or polishing) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 12:49 |

| | | | | | | |
|-----|-----|---|---|----|----|------------------|
| S14 | 261 | S12 and (plating or polishing or electroplating or electropolishing) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 15:27 |
| S15 | 376 | S12 and (plating or polishing or etching or electroplating or electropolishing or electroetching) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 12:50 |
| S16 | 54 | S15 and computer | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 12:57 |
| S17 | 18 | "3959088" | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 14:51 |
| S18 | 2 | "3959088".pn. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 12:57 |
| S19 | 14 | ("6722942" "6736952").PN. or ("20020115283" "20040192052" "20050059324" "5162248" "6176992" "6395607" "6433929" "6504247" "6753250" "6780772" "6881664").PN. or ("20030064669").PN. | US-PGPUB; USPAT | OR | ON | 2005/08/31 14:52 |
| S20 | 0 | S19 and (AC or (alternat\$4 adj current)) and (DC or (direct adj current)) same switch\$4 | US-PGPUB; USPAT | OR | ON | 2005/08/31 14:53 |
| S21 | 0 | S19 and (AC or (alternat\$4 adj current)) and (DC or (direct adj current)) | US-PGPUB; USPAT | OR | ON | 2005/08/31 14:53 |
| S22 | 160 | S14 and ((AC with DC) or ((alternat\$4 near5 current) with (direct near5 current))) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 15:29 |

| | | | | | | |
|-----|------|--|---|----|----|------------------|
| S23 | 43 | S14 and ((AC with DC) or ((alternat\$4 near5 current) with (direct near5 current))) with switch\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 15:29 |
| S24 | 1116 | ("204"/\$.ccls. or "205"/\$.ccls.) and (AC or (alternat\$4 adj current)) and (DC or (direct adj current)) same switch\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 17:17 |
| S25 | 261 | S24 and (plating or polishing or electroplating or electropolishing) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 18:33 |
| S26 | 43 | S25 and ((AC with DC) or ((alternat\$4 near5 current) with (direct near5 current))) with switch\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 17:18 |
| S27 | 9 | S26 and superimpos\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 17:18 |
| S28 | 14 | ("6722942" "6736952").PN. or ("20020115283" "20040192052" "20050059324" "5162248" "6176992" "6395607" "6433929" "6504247" "6753250" "6780772" "6881664").PN. or ("20030064669").PN. | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:29 |
| S29 | 35 | ("5843818" "5888866" "6103636" "6162681" "6461911").PN. or ("20030178320" "5624300" "6103636" "6689258" "6776693").PN. or ("2315695" "2516105" "20020104764" "3334210" "5098533" "5562529" "6007695" "6190494" "6322422" "6368184" "6464855" "6620037").PN. or ("20010025976" "5344539" "5952687" "6024856" "6103096" "6115233" "6132586" "6174425" "6180947" "6197182" "6259128" "6280581" "6303956" "6379223").PN. | US-PGPUB; USPAT | OR | ON | 2005/08/31 17:26 |
| S30 | 49 | S28 or S29 | US-PGPUB; USPAT | OR | ON | 2005/08/31 19:05 |

| | | | | | | |
|-----|-----|---|---|----|----|------------------|
| S31 | 19 | ("4995953" "5139624" "5464509" "5597346" "5679065" "5681215" "5695392" "5803799" "5846398" "5931725" "5941758" "6004193" "6017437" "6093089" "6110025" "6116992" "6171467" "6224472" "6440295").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2005/08/31 17:48 |
| S32 | 22 | ("3849272" "5256565" "5265378" "5567300" "5575706" "5605488" "5853317" "5863412" "5882251" "5911619" "5934974" "5934977" "5993637" "6017437" "6056869" "6077412" "6106662" "6121144" "6176992" "6368190" "6379223" "6464855").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2005/08/31 17:53 |
| S33 | 377 | landau.in. | US-PGPUB; USPAT | OR | ON | 2005/08/31 18:22 |
| S34 | 74 | (electroplating or electropolishing) and ((polishing adj (pad or article)) or (WSID)) and (contact adj (ring or pin or finger or element)) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 18:35 |
| S35 | 51 | (electropolishing) and ((polishing adj (pad or article)) or (WSID)) and (contact adj (ring or pin or finger or element)) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 18:44 |
| S36 | 18 | S35 and face with up with down | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 18:52 |
| S37 | 17 | S35 and fac\$3 adj up and fac\$3 adj down | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 18:53 |
| S38 | 1 | S37 not S36 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 18:53 |

| | | | | | | |
|-----|------|--|---|----|----|------------------|
| S39 | 5 | (S34 and fac\$3 adj up and fac\$3 adj down) not S36 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 18:54 |
| S40 | 49 | emesh.in. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 18:54 |
| S41 | 0 | S40 and fac\$3 adj up and fac\$3 adj down | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 18:55 |
| S42 | 7 | S40 and up and down | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 19:02 |
| S43 | 8 | S40 and table | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 19:02 |
| S44 | 24 | S30 and (table or support) | US-PGPUB; USPAT | OR | ON | 2005/08/31 19:05 |
| S45 | 17 | 205/123.ccls. and (DC or (direct adj current))and (AC or (alternating adj current)) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/31 19:24 |
| S50 | 254 | ("204"/\$.ccls. or "205"/\$.ccls.) and (DC or (direct adj current)) with (AC or (alternating adj current)) with pulsed | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:49 |
| S51 | 36 | S50 and (electroplating or electropolishing) | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:33 |
| S52 | 2752 | ("204"/\$.ccls. or "205"/\$.ccls.) and (DC or (direct adj current)) with (AC or (alternating adj current)) | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:37 |
| S54 | 314 | S52 and (electroplating or electropolishing) | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:34 |

| | | | | | | |
|-----|------|---|--------------------|----|----|------------------|
| S55 | 183 | S52 and (polishing) | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:50 |
| S56 | 87 | S55 and (semiconductor or wafer) | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:35 |
| S57 | 69 | S55 and (semiconductor or wafer) and copper | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:37 |
| S58 | 1518 | dubin | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:37 |
| S59 | 165 | dubin and ("204"/\$.ccls. or "205"/\$.ccls.) | US-PGPUB; USPAT | OR | ON | 2005/09/01 08:43 |
| S60 | 5 | S59 and (DC or (direct adj current)) with (AC or (alternating adj current)) | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:38 |
| S61 | 107 | poris and ("204"/\$.ccls. or "205"/\$.ccls.) | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:38 |
| S62 | 5 | S60 and (DC or (direct adj current)) with (AC or (alternating adj current)) | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:38 |
| S63 | 233 | ("204"/\$.ccls. or "205"/\$.ccls.) and (DC or (direct adj current)) with (AC or (alternating adj current)) with superimposed | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:49 |
| S64 | 21 | S63 and (polishing) | US-PGPUB; USPAT | OR | ON | 2005/08/31 21:50 |